Si8810EDB

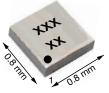
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Vishay Siliconix

N-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω) MAX.	I _D (A) ^a	Q _g (TYP.)			
20	0.072 at V_{GS} = 4.5 V	2.9				
	0.079 at V_{GS} = 2.5 V	2.8	3 nC			
	0.092 at V _{GS} = 1.8 V	2.6	3110			
	0.125 at V _{GS} = 1.5 V	2.2				

MICRO FOOT® 0.8 x 0.8





Backside View

Bump Side View

Marking Code: xx = AJ xxx = Date/Lot traceability code

Ordering Information:

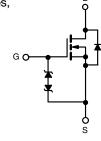
Si8810EDB-T2-E1 (lead (Pb)-free and halogen-free)

FEATURES

- TrenchFET[®] power MOSFET
- Ultra small 0.8 mm x 0.8 mm outline
- Ultra thin 0.357 mm height
- Typical ESD protection 2000 V (HBM)
- FREE · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Portable devices such as cell phones, smart phones, and tablet PCs
 - Load switch
 - Small signal switch
 - High speed switching



N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S (T _A = 25 °C, u	Inless otherwi	ise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	20	V	
Gate-Source Voltage		V _{GS}	± 8		
	T _A = 25 °C		2.9 ^a		
Continuous Drain Current (T. 150 °C)	T _A = 70 °C	Ι. Γ	2.3 ^a		
Continuous Drain Current ($T_J = 150 \ ^\circ C$)	T _A = 25 °C	I _D	2.1 ^b		
	T _A = 70 °C	1 Г	1.7 ^b	А	
Pulsed Drain Current (t = 300 µs)		I _{DM}	15		
Continuous Source-Drain Diode Current	T _A = 25 °C		0.7 ^a		
	T _A = 25 °C	Is I	0.4 ^b		
Maximum Power Dissipation	T _A = 25 °C		0.9 ^a		
	T _A = 70 °C		0.6 ^a	w	
	T _A = 25 °C	P _D	0.5 ^b	vv	
	T _A = 70 °C	1 –	0.3 ^b		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C	
Soldering Recommendations (Peak Temperature) ^c			260		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum Junction-to-Ambient a, d	t≤5 s	R _{thJA}	105	135	°C/W	
Maximum Junction-to-Ambient ^{b, e}	1238		200	260		

Notes

a. Surface mounted on 1" x 1" FR4 board with full copper, t = 5 s.

b. Surface mounted on 1" x 1" FR4 board with minimum copper, t = 5 s.

c. Refer to IPC/JEDEC® (J-STD-020), no manual or hand soldering.

d. Maximum under steady state conditions is 185 °C/W.

e. Maximum under steady state conditions is 330 °C/W.

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1



COMPLIANT

HALOGEN

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Si8810EDB

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	STMBOL	TEST CONDITIONS	IVIIIN.	116.	IVIAA.	UNIT	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	20	-	-	V	
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	VGS - 0 V, ID - 200 µA	20	21	_	mV/°C	
V _{GS(th)} Temperature Coefficient		I _D = 250 μA	_	-2.7	_		
Gate-Source Threshold Voltage	ΔV _{GS(th)} /T _J	V _{DS} = V _{GS} , I _D = 250 μA	0.4	-2.1	0.9		
Gale-Source mieshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 230 \ \mu A$ $V_{DS} = 0 \ V$, $V_{GS} = \pm 4.5 \ V$	0.4	-	± 0.5	v	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 4.3 V$ $V_{DS} = 0 V, V_{GS} = \pm 8 V$	-	-		- μA	
	I _{DSS}		-	-	± 5		
Zero Gate Voltage Drain Current		$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	-	
		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$	-	-	10	•	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 V, V_{GS} = 4.5 V$	10	-	-	A	
		$V_{GS} = 4.5 \text{ V}, I_D = 1 \text{ A}$	-	0.058	0.072	4	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 2.5 \text{ V}, I_D = 1 \text{ A}$	-	0.063	0.079	Ω	
		$V_{GS} = 1.8 \text{ V}, \text{ I}_{D} = 1 \text{ A}$	-	0.072	0.092		
	_	$V_{GS} = 1.5 \text{ V}, \text{ I}_{D} = 0.5 \text{ A}$	-	0.080	0.125		
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 10 V, I_{D} = 1 A$	-	12	-	S	
Dynamic ^b	I		•	•	1	•	
Input Capacitance	C _{iss}		-	245	-	1	
Output Capacitance	C _{oss}	$V_{DS} = 10 V, V_{GS} = 0 V, f = 1 MHz$	-	55	-	pF	
Reverse Transfer Capacitance	C _{rss}		-	25	-		
Total Gate Charge	Qg	$V_{DS} = 10 \text{ V}, V_{GS} = 8 \text{ V}, I_D = 1 \text{ A}$	-	5.2	8	nC	
Total date onlarge			-	3	4.5		
Gate-Source Charge	Q _{gs}	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 1 \text{ A}$	-	0.35	-		
Gate-Drain Charge	Q _{gd}		-	0.45	-		
Gate Resistance	Rg	f = 1 MHz	-	5	-	Ω	
Turn-On Delay Time	t _{d(on)}		-	7	15	ns	
Rise Time	t _r	$V_{DD} = 10 \text{ V}, \text{ R}_{\text{L}} = 10 \Omega$	-	12	25		
Turn-Off Delay Time	t _{d(off)}	$I_{D}\cong1\;A,V_{GEN}=4.5\;V,R_{g}=1\;\Omega$	-	25	50		
Fall Time	t _f		-	7	15		
Turn-On Delay Time	t _{d(on)}		-	5	10		
Rise Time	t _r	$V_{DD} = 10 \text{ V}, \text{ R}_{\text{I}} = 10 \Omega$	-	10	20		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 1 \text{ A}, V_{GEN} = 8 \text{ V}, R_g = 1 \Omega$	-	15	30		
Fall Time	t _f		-	7	15		
Drain-Source Body Diode Characteristic		· · · · · · · · · · · · · · · · · · ·	1		1		
Continuous Source-Drain Diode Current	IS	T _C = 25 °C	-	-	0.7	A	
Pulse Diode Forward Current	I _{SM}	-	-	-	15		
Body Diode Voltage	V _{SD}	I _S = 1 A, V _{GS} = 0 V	-	0.7	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}	<u> </u>	-	11	20	ns	
Body Diode Reverse Recovery Charge	Q _{rr}		-	5	10	nC	
Reverse Recovery Fall Time t _a		I _F = 1 A, dl/dt = 100 A/μs, T _J = 25 °C	-	7	-		
Reverse Recovery Rise Time	t _a			4	_	ns	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

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Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2

 $T_J = 25 \ ^{\circ}C$

12

16

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



8

V_{GS} - Gate-Source Voltage (V)

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2.50

2.00

1.50

1.00

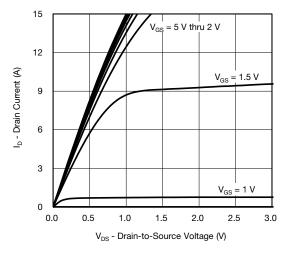
0.50

0.00

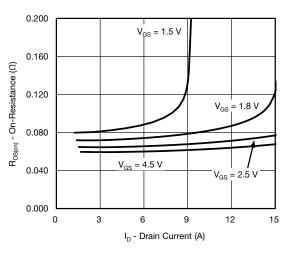
0

4

I_{GSS} - Gate Current (mA)



Output Characteristics



On-Resistance vs. Drain Current

I_{GSS} - Gate Current (A) 10⁻⁶ T, = 25 °C 10⁻⁷ 10⁻⁸ 10⁻⁹ 0 4 8 V_{GS} - Gate-to-Source Voltage (V)

10⁻²

10⁻³

10⁻⁴

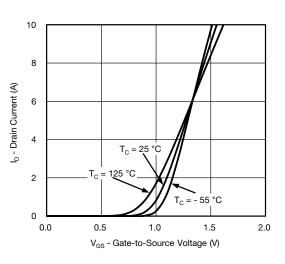
10⁻⁵

Gate Current vs. Gate-Source Voltage

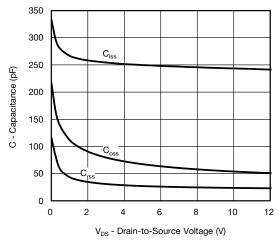
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16

T_J = 150 °C



Transfer Characteristics



Capacitance vs. Drain-to-Source Voltage

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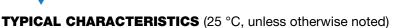
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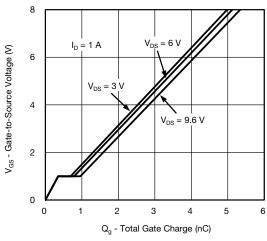
Document Number: 62829

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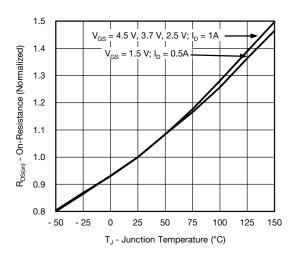
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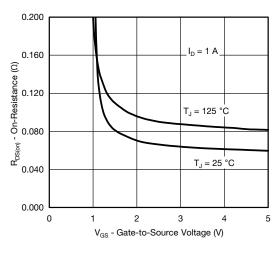


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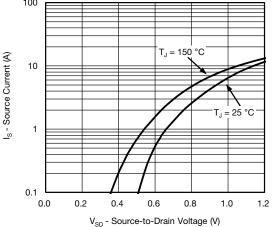
Gate Charge



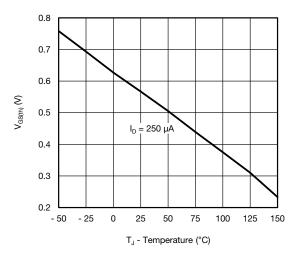
On-Resistance vs. Junction Temperature



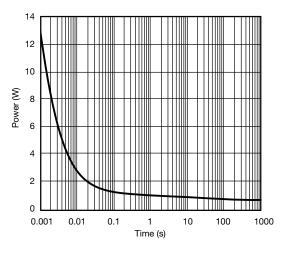
On-Resistance vs. Gate-to-Source Voltage



Source-Drain Diode Forward Voltage



Threshold Voltage



Single Pulse Power (Junction-to-Ambient)

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Document Number: 62829

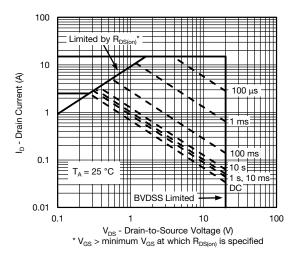
4 For technical questions, contact: pmostechsupport@vishay.com

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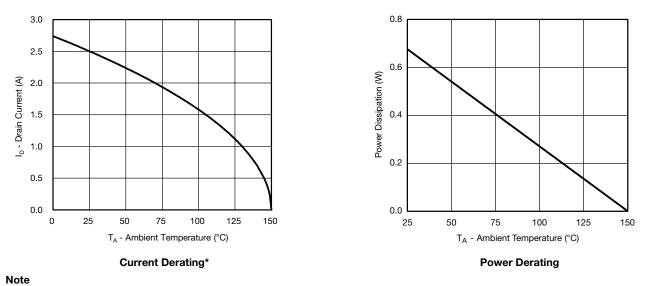


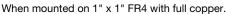
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Safe Operating Area, Junction-to-Ambient





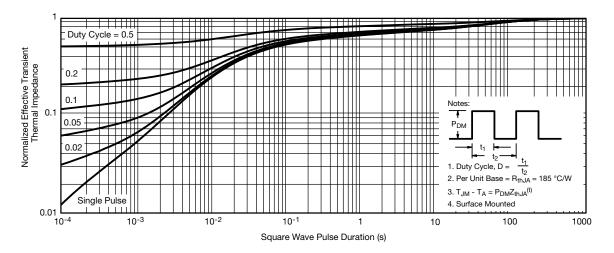
* The power dissipation P_D is based on $T_{J (max.)} = 150 \text{ °C}$, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



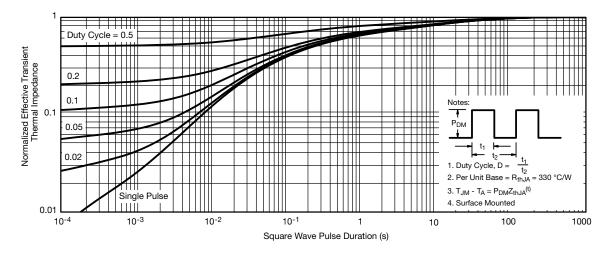
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient (on 1" x 1" FR4 board with maximum copper)



Normalized Thermal Transient Impedance, Junction-to-Ambient (on 1" x 1" FR4 board with minimum copper)

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